

Product Change Notice

QD4-099 Rev.A0

Product(s) Affected: **Standard UP series**

UP-CHT01

Old P/N	New P/N
UP-CHT01-A10/A20-0116	UP-CHT01-A20-0116-A11
UP-CHT01-A10/A20-0216	UP-CHT01-A20-0216-A11
UP-CHT01-A10/A20-0232	UP-CHT01-A20-0232-A11
UP-CHT01-A10/A20-0432	UP-CHT01-A20-0432-A11
UP-CHT01-A10/A20-0464	UP-CHT01-A20-0464-A11
UP-CHT01-A11-0432	UP-CHT01-A21-0432-A11
UP-CHT01-A12-0216	UP-CHT01-A22-0216-A11
UP-CHT01-A12-0232	UP-CHT01-A22-0232-A11
UP-CHT01-A12-0432	UP-CHT01-A22-0432-A11

Date Effective: active by running change from May, 2019.

Date of Publication : 23-05-2019

Changes to Product : Package, PCB and eMMC			
Model Name		Description	
UP-CHT01		UP-CHT01.w/ z8350 CPU.MAX 4G memory.MAX 64G eMMC	
<p>Details of Change:</p> <ol style="list-style-type: none"> The product is changed from a bulk package to color box package. Implemented over-voltage power-in prevention Power circuit modification to prevent booting error at high frequency power on-off. Change eMMC brand from Hynix to Sandisk(32G/64G) and Kingston(16G) 3D flash due to Hynix eMMC EOL. Qualified both Sandisk/Kingston eMMC 			
<p>■Benefit: Enhance system stability t high frequency power on-off</p>			
Pre-Change		Post-Change	
<ol style="list-style-type: none"> Hynix eMMC PCB A1.0 Bulk package 		<ol style="list-style-type: none"> Sandisk 3D eMMC(32G/64G); Kingston 3D eMMC(16G) PCB A1.1 Color box package 	
Issue Date	May 23, 2019	Issue by	Irene Lin